

Fully Automated Wide Temperature Range Semiconductor Characterization

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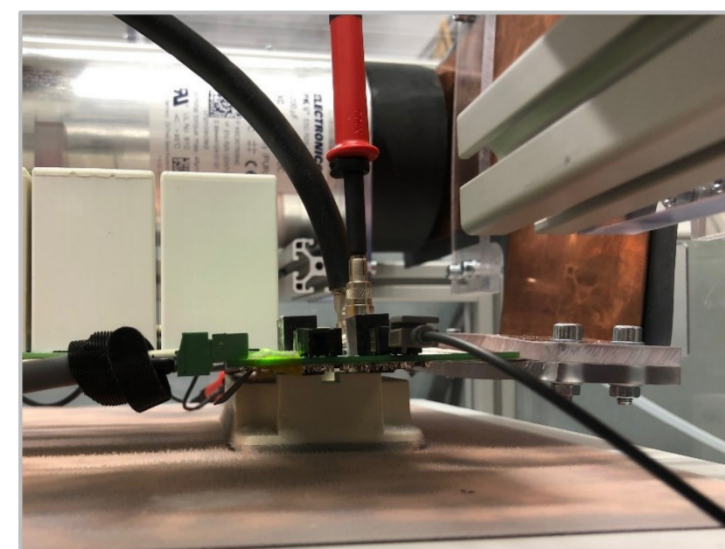


Motivation

Properties

- Lower $R_{DS(on)}$
- Lower forward voltage
- Faster switching
- Lower switching losses
- Reduced cooling effort due to thermal isolation
- ➔ Higher system efficiency

Low Temperature Power Electronics



Module at -70 °C

Applications

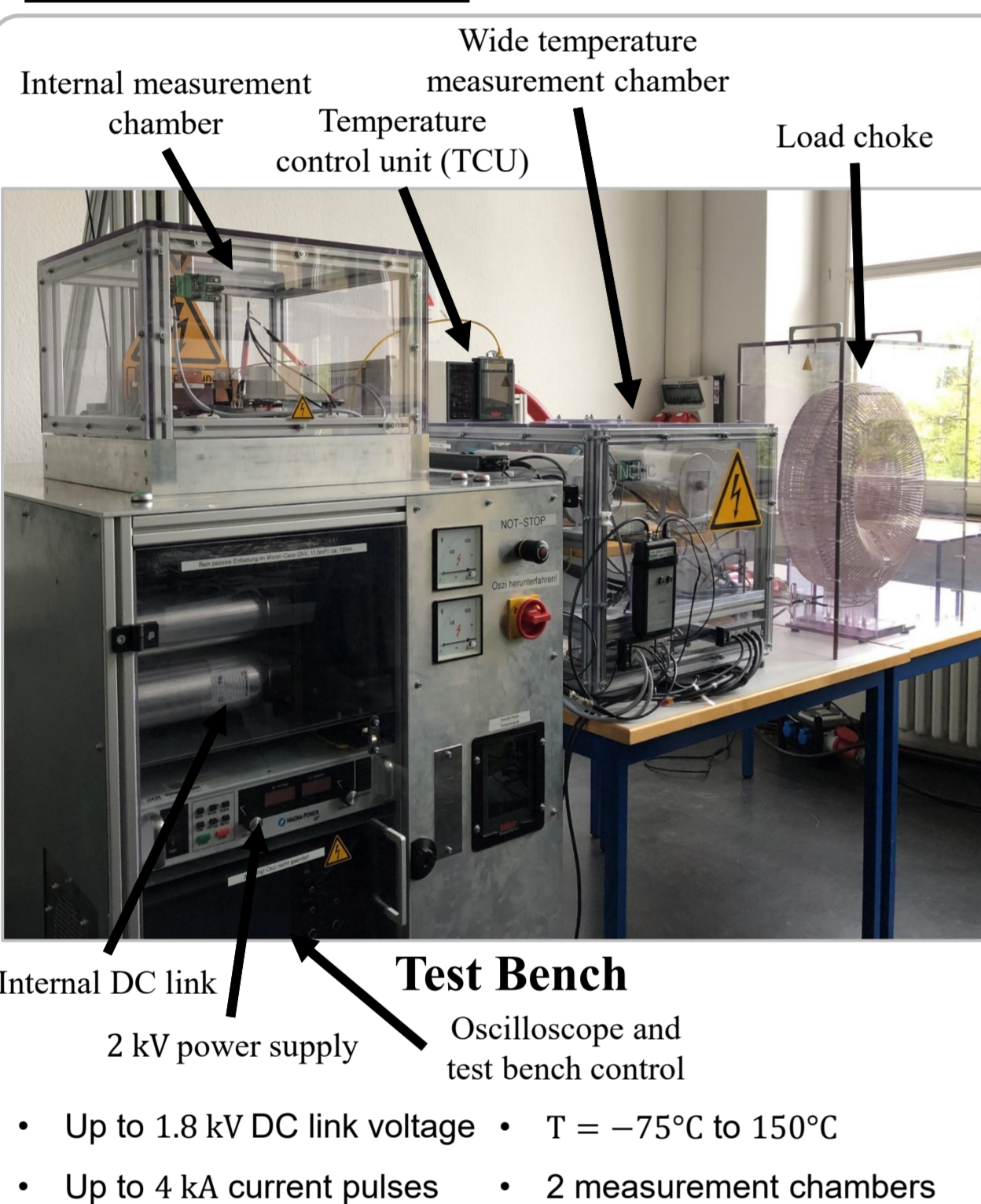
- Superconducting motors and generators
- Superconducting transmission lines

Wide Temperature Range Semiconductor Characterization

- Precise temperature control
- Ensure safe temperature operating area of periphery
- Whole module measurement
- Prevent icing
- Easy and flexible configuration, measurement, data evaluation
- Affordable measurement technology

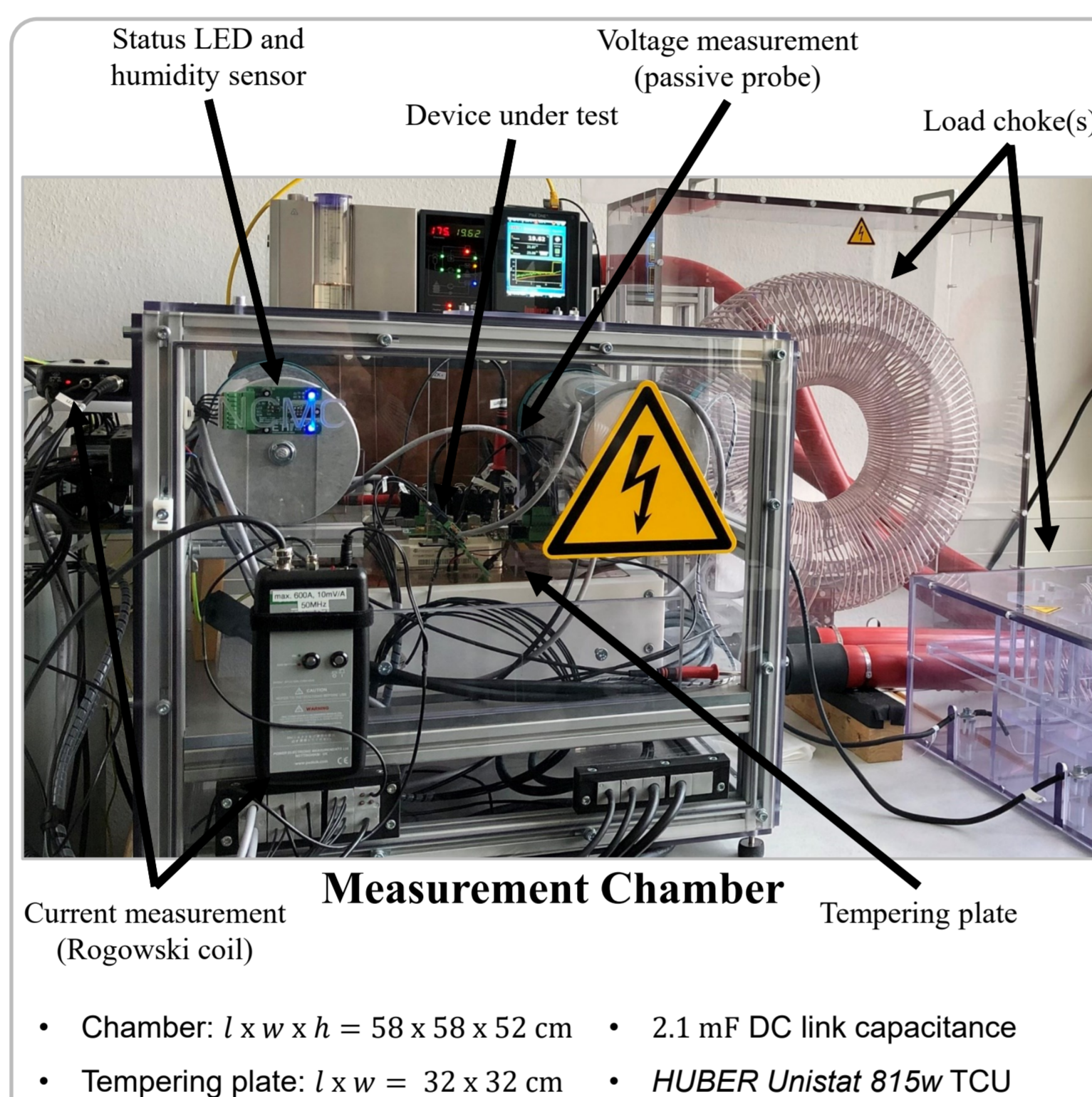
- Temperature control unit
- Tempering plate instead of climatic chamber
- Hermetic, nitrogen filled measurement chamber
- In-house developed control and evaluation software
- Minimized setup (no helium chillers, curve tracers..)

Semiconductor Test Bench

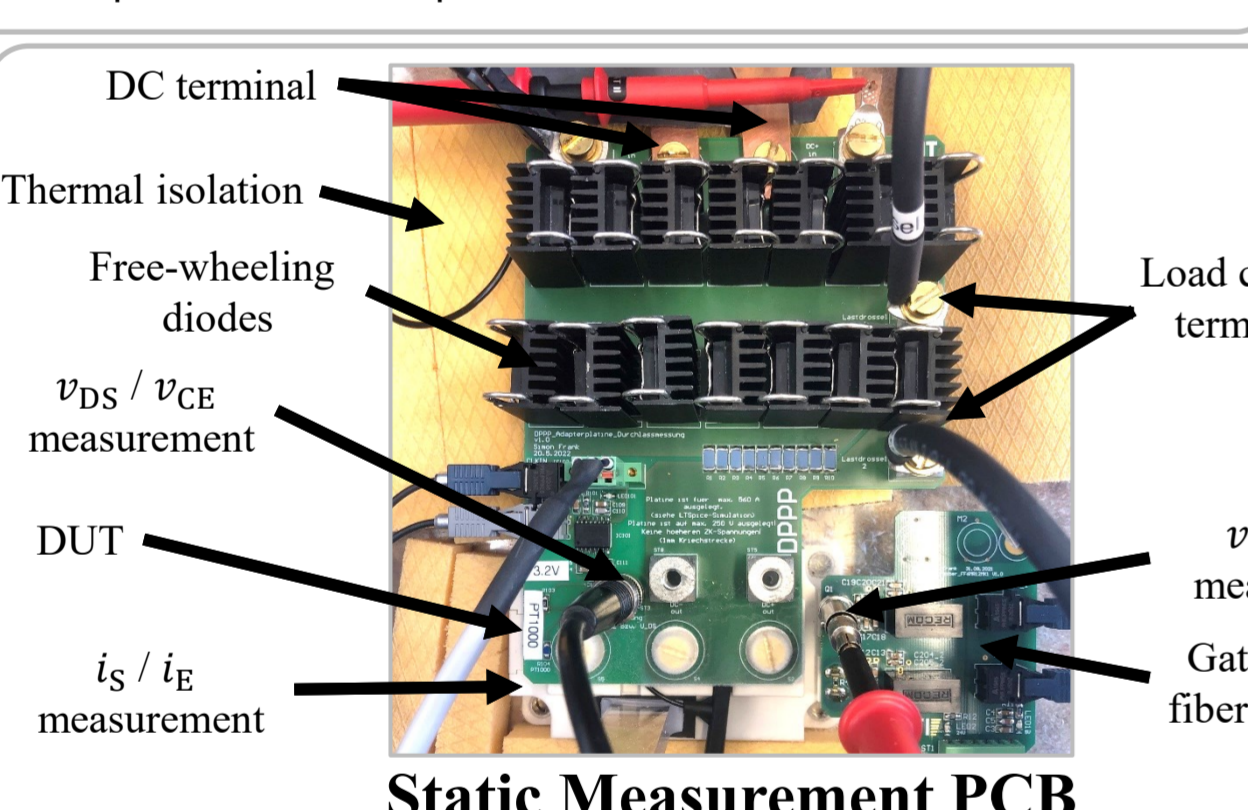


- Up to 1.8 kV DC link voltage
- $T = -75^\circ\text{C}$ to 150°C
- Up to 4 kA current pulses
- 2 measurement chambers

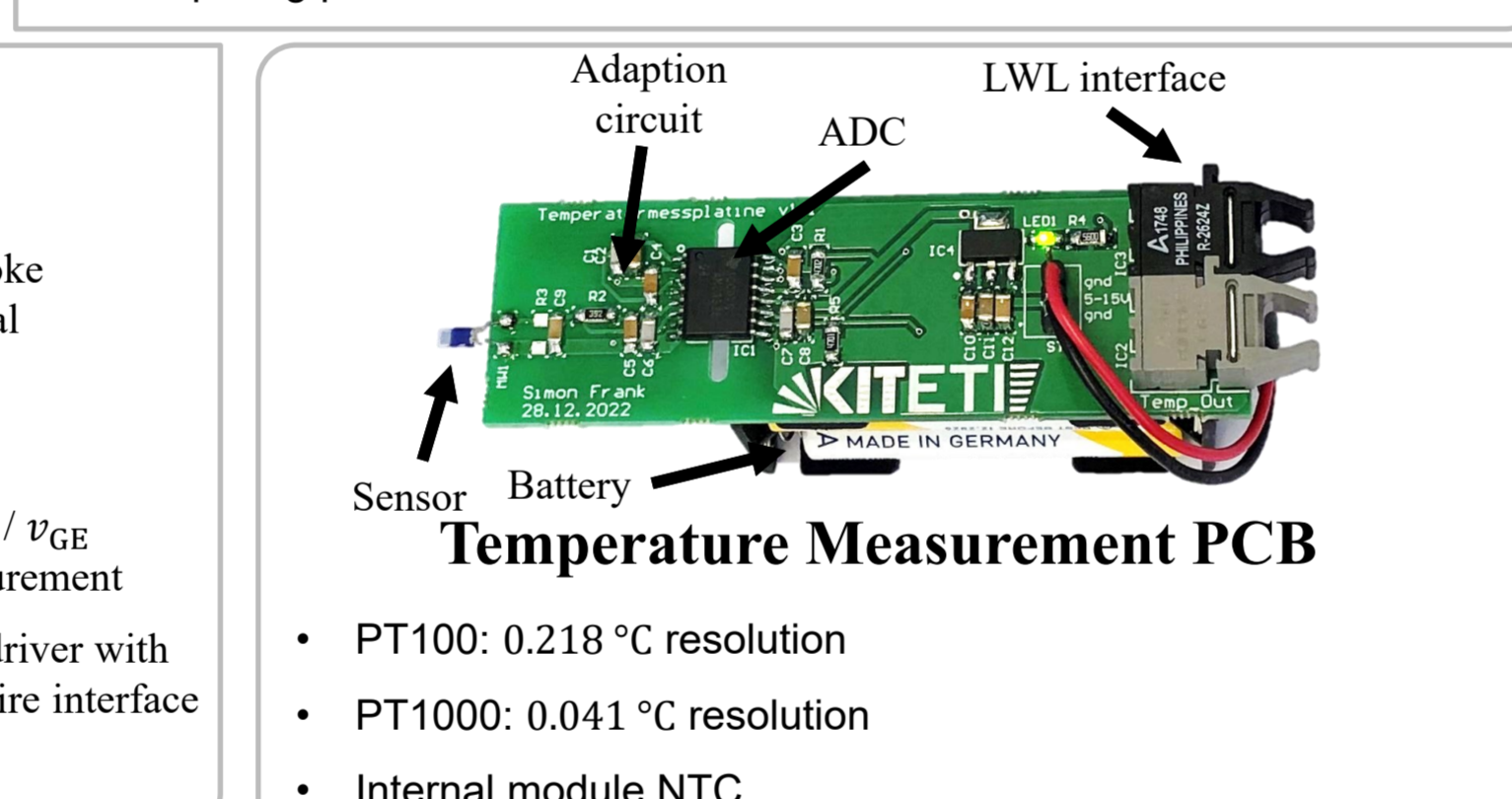
Hardware Setup



- Chamber: $l \times w \times h = 58 \times 58 \times 52$ cm
- Tempering plate: $l \times w = 32 \times 32$ cm
- 2.1 mF DC link capacitance
- HUBER Unistat 815w TCU



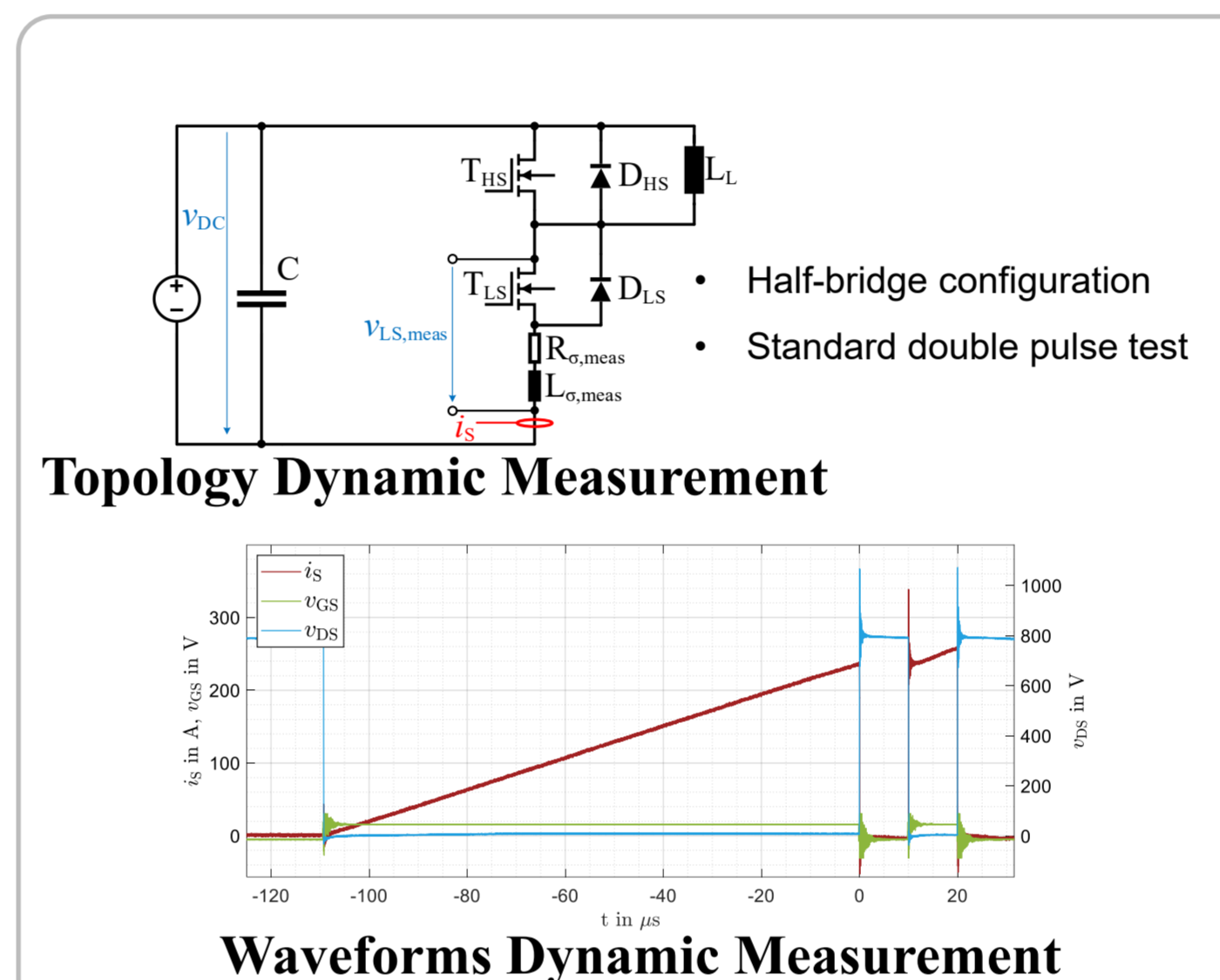
Static Measurement PCB



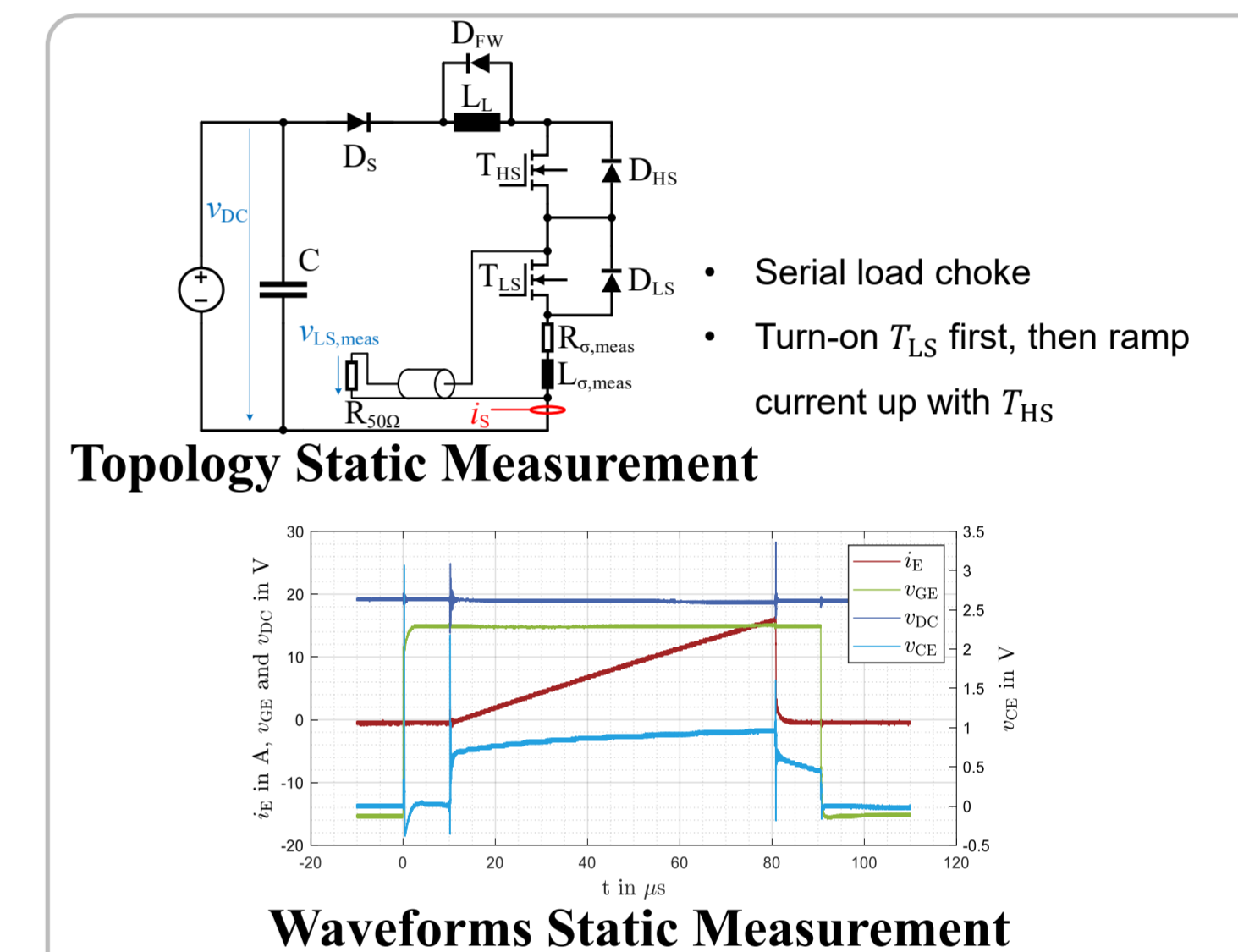
Temperature Measurement PCB

Measurement Setup

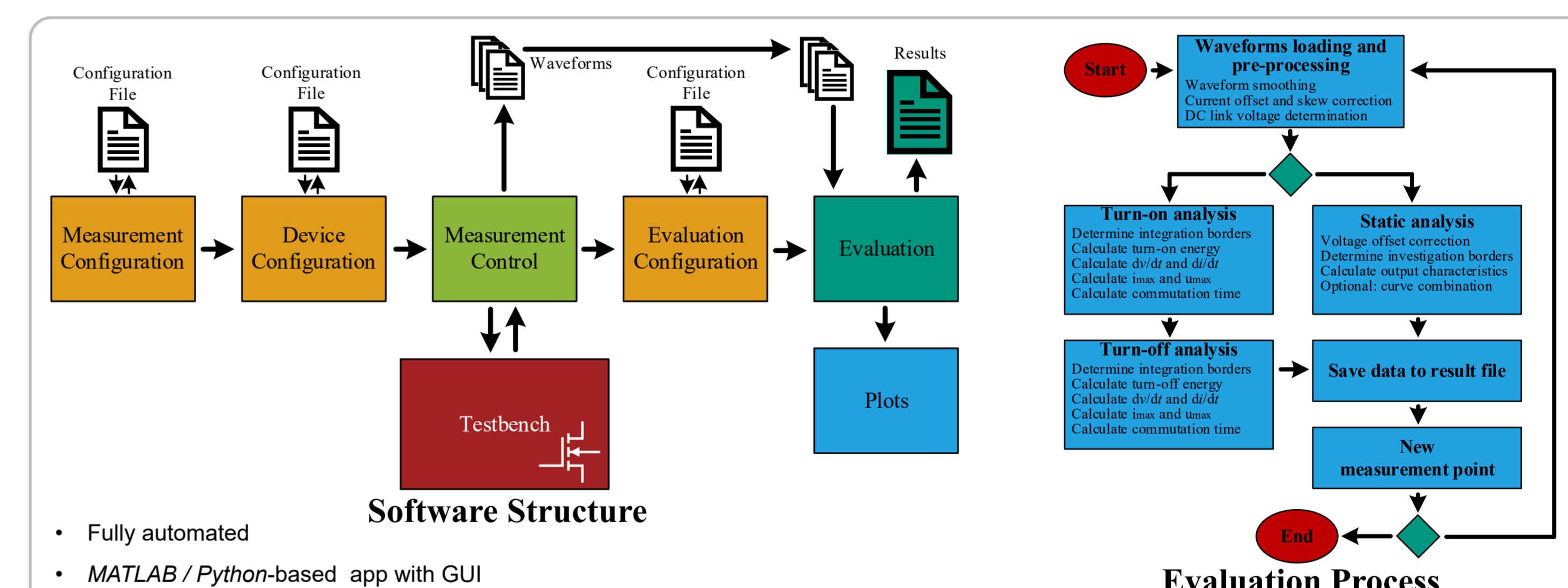
Dynamic Behavior



Static Behavior

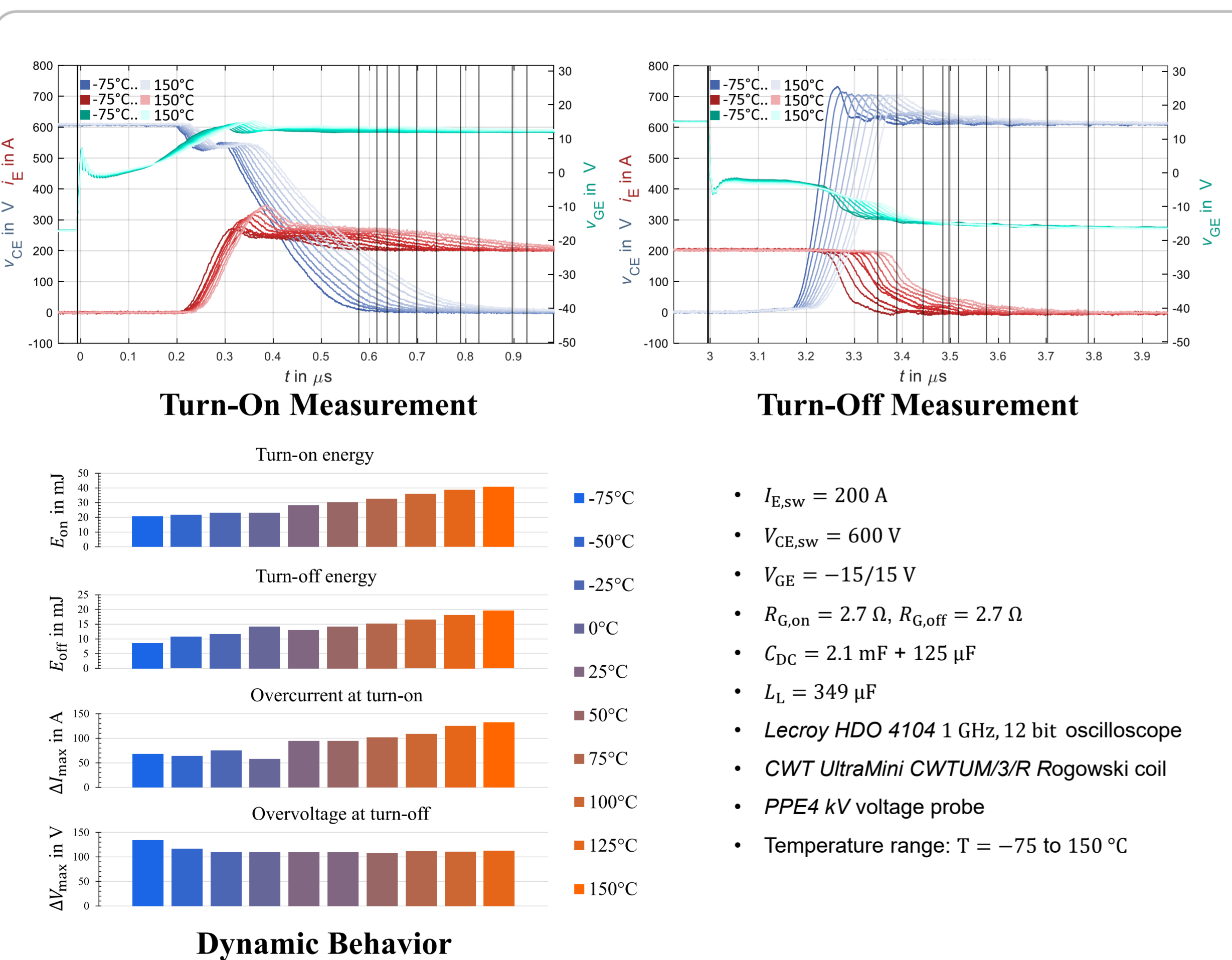


Control and Data Evaluation

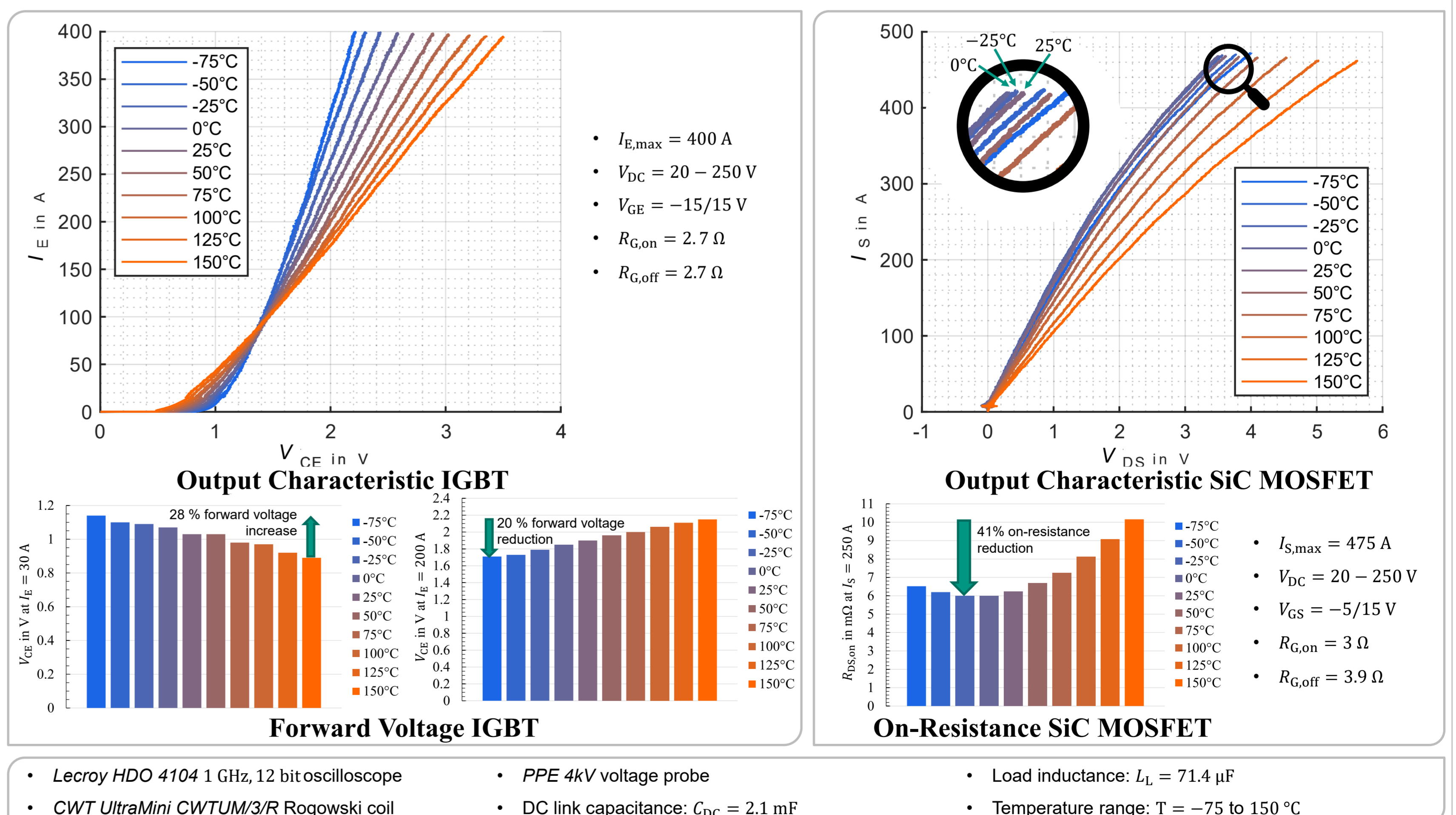


Results

Dynamic Behavior



si-IGBT ← Output Characteristics → siC-MOSFET



Summary

- Easy-to-use, flexible, wide temperature range test bench for static and dynamic characterization of power semiconductors
- Operation proofed over the temperature range from -75 to 150°C
- Static characterization without additional curve tracer
- Results promise more efficient converters when operated at lower temperatures

Future work

- Test bench adaption to GaN semiconductors
- Breakdown voltage measurements
- Further semiconductor measurements over a wide temperature range

